## : ©hipsmall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation, and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!


## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832
Email \& Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, \#122 Zhenhua RD., Futian, Shenzhen, China

## FEATURES

RF frequency range of $\mathbf{2 2 0 0} \mathbf{~ M H z}$ to $\mathbf{2 7 0 0} \mathbf{~ M H z}$
IF frequency range of $\mathbf{3 0} \mathbf{~ M H z}$ to $\mathbf{4 5 0} \mathbf{~ M H z}$
Power conversion gain: $\mathbf{8 . 6} \mathrm{dB}$
SSB noise figure of $\mathbf{1 0 . 6 ~ d B}$
Input IP3 of $\mathbf{2 6 . 1} \mathbf{~ d B m}$
Input P1dB of 10.6 dBm
Typical LO power of 0 dBm
Single-ended, $50 \Omega$ RF and LO input ports
High isolation SPDT LO input switch
Single-supply operation: 3.3 V to 5 V
Exposed paddle, $6 \mathrm{~mm} \times 6 \mathrm{~mm}$, 36-lead LFCSP
1500 V HBM/500 V FICDM ESD performance

## APPLICATIONS

## Cellular base station receivers

Transmit observation receivers
Radio link downconverters

## GENERAL DESCRIPTION

The ADL5354 uses a highly linear, doubly balanced, passive mixer core along with integrated RF and local oscillator (LO) balancing circuitry to allow single-ended operation. The ADL5354 incorporates the RF baluns, allowing for optimal performance over a 2200 MHz to 2700 MHz RF input frequency range. The balanced passive mixer arrangement provides good LO-to-RF leakage, typically better than -37 dBm , and excellent intermodulation performance. The balanced mixer core also provides extremely high input linearity, allowing the device to be used in demanding cellular applications where in-band blocking signals may otherwise result in the degradation of dynamic performance. A high linearity IF buffer amplifier follows the passive mixer core to yield a typical power conversion gain of 8 dB and can be used with a wide range of output impedances.
The ADL5354 provides two switched LO paths that can be used in time division duplex (TDD) applications where it is desirable to ping-pong between two local oscillators. LO current can be externally set using a resistor to minimize dc current

Rev. 0
Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106, U.S.A.

## ADL5354

## TABLE OF CONTENTS

Features .....  1
Applications ..... 1
Functional Block Diagram ..... 1
General Description ..... 1
Revision History ..... 2
Specifications .....  3
5 V Performance ..... 4
3.3 V Performance ..... 4
Absolute Maximum Ratings ..... 5
ESD Caution ..... 5
Pin Configuration and Function Descriptions ..... 6
Typical Performance Characteristics ..... 7
5 V Performance ..... 7
3.3 V Performance. ..... 14
Spur Tables ..... 15
5 V Performance ..... 15
3.3 V Performance ..... 15
Circuit Description ..... 16
RF Subsystem ..... 16
LO Subsystem ..... 16
Applications Information ..... 18
Basic Connections ..... 18
IF Port ..... 18
Bias Resistor Selection ..... 18
Mixer VGS Control DAC ..... 18
Evaluation Board ..... 20
Outline Dimensions ..... 22
Ordering Guide ..... 22

## REVISION HISTORY

## 2/11—Revision 0: Initial Version

## SPECIFICATIONS

$\mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=350 \mathrm{~mA}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{RF}}=2535 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=2332 \mathrm{MHz}$, LO power $=0 \mathrm{dBm}$, RF power $=-10 \mathrm{dBm}, \mathrm{R} 1=\mathrm{R} 4=1.3 \mathrm{k} \Omega$, $\mathrm{R} 2=$ $\mathrm{R} 5=1 \mathrm{k} \Omega, \mathrm{Z}_{\mathrm{o}}=50 \Omega, \mathrm{VGS} 0=\mathrm{VGS} 1=\mathrm{VGS} 2=0 \mathrm{~V}$, unless otherwise noted.

Table 2.

| Parameter | Test Conditions/Comments | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| RF INPUT INTERFACE <br> Return Loss <br> Input Impedance <br> RF Frequency Range | Tunable to >20 dB over a limited bandwidth | $2200$ | $\begin{aligned} & 20 \\ & 50 \end{aligned}$ | 2700 | dB <br> $\Omega$ <br> MHz |
| OUTPUT INTERFACE <br> Output Impedance <br> IF Frequency Range DC Bias Voltage ${ }^{1}$ | Differential impedance, $\mathrm{f}=200 \mathrm{MHz}$ <br> Externally generated | $\begin{aligned} & 30 \\ & 3.3 \end{aligned}$ | $\begin{aligned} & 230\|\mid 0.75 \\ & 5.0 \end{aligned}$ | $\begin{aligned} & 450 \\ & 5.5 \end{aligned}$ | $\begin{aligned} & \Omega \\| \mathrm{pF} \\ & \mathrm{MHz} \\ & \mathrm{~V} \end{aligned}$ |
| LO INTERFACE <br> LO Power <br> Return Loss <br> Input Impedance <br> LO Frequency Range |  | $-6$ $1750$ | $\begin{aligned} & 0 \\ & 13 \\ & 50 \end{aligned}$ | $\begin{aligned} & +10 \\ & 2670 \end{aligned}$ | dBm <br> dB <br> $\Omega$ <br> MHz |
| POWER-DOWN (PWDN) INTERFACE² <br> PWDN Threshold <br> Logic 0 Level <br> Logic 1 Level PWDN Response Time <br> PWDN Input Bias Current | Device enabled, IF output to $90 \%$ of its final level <br> Device disabled, supply current < 5 mA <br> Device enabled <br> Device disabled | 1.4 | $\begin{aligned} & 1.0 \\ & \\ & 160 \\ & 230 \\ & 0 \\ & 70 \end{aligned}$ | 0.4 | V <br> V <br> V <br> ns <br> ns <br> $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ |

[^0]
## ADL5354

## 5 V PERFORMANCE

$\mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=350 \mathrm{~mA}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{RF}}=2535 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=2332 \mathrm{MHz}$, LO power $=0 \mathrm{dBm}, \mathrm{RF}$ power $=-10 \mathrm{dBm}, \mathrm{R} 1=\mathrm{R} 4=1.3 \mathrm{k} \Omega, \mathrm{R} 2=\mathrm{R} 5=1 \mathrm{k} \Omega$, $\mathrm{VGS} 0=\mathrm{VGS} 1=\mathrm{VGS} 2=0 \mathrm{~V}$, and $\mathrm{Z}_{\mathrm{O}}=50 \Omega$, unless otherwise noted.

Table 3.

| Parameter | Test Conditions/Comments | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCE |  |  |  |  |  |
| Power Conversion Gain | Including 4:1 IF port transformer and PCB loss |  | 8.6 |  | dB |
| Voltage Conversion Gain | $Z_{\text {SOURCE }}=50 \Omega$, differential $Z_{\text {LOAD }}=200 \Omega$ differential |  | 14.6 |  | dB |
| SSB Noise Figure |  |  | 10.6 |  | dB |
| Input Third-Order Intercept (IIP3) | $f_{\mathrm{RF} 1}=2534.5 \mathrm{MHz}, \mathrm{f}_{\mathrm{RF} 2}=2535.5 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=2332 \mathrm{MHz},$ $\text { each } R F \text { tone at }-10 \mathrm{dBm}$ |  | 26.1 |  | dBm |
| Input Second-Order Intercept (IIP2) | $\begin{aligned} & \mathrm{f}_{\mathrm{RF} 1}=2535 \mathrm{MHz}, \mathrm{f}_{\mathrm{R} F 2}=2585 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=2332 \mathrm{MHz}, \\ & \text { each RF tone at }-10 \mathrm{dBm} \end{aligned}$ |  | 50 |  | dBm |
| Input 1 dB Compression Point (IP1dB) |  |  | 10.6 |  | dBm |
| LO-to-IF Leakage | Unfiltered IF output |  | -20.7 |  | dBm |
| LO-to-RF Leakage |  |  | -37 |  | dBm |
| RF-to-IF Isolation |  |  | -34 |  | dBc |
| IF/2 Spurious | -10 dBm input power |  | -73 |  | dBc |
| IF/3 Spurious | -10 dBm input power |  | -71 |  | dBc |
| IF Channel-to-Channel Isolation |  |  | 52 |  | dB |
| POWER SUPPLY |  |  |  |  |  |
| Positive Supply Voltage |  | 4.75 | 5 | 5.25 | V |
| Quiescent Current | LO supply |  | 170 |  | mA |
|  | IF supply |  | 180 |  | mA |
| Total Quiescent Current | $\mathrm{V}_{\mathrm{s}}=5 \mathrm{~V}$ |  | 350 |  | mA |

### 3.3 V PERFORMANCE

$\mathrm{V}_{\mathrm{S}}=3.3 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=200 \mathrm{~mA}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{RF}}=2535 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=2332 \mathrm{MHz}$, LO power $=0 \mathrm{dBm}, \mathrm{R} 9=226 \Omega, \mathrm{R} 14=604 \Omega$, VGS0 $=\mathrm{VGS} 1=0 \mathrm{~V}$, and $Z_{O}=50 \Omega$, unless otherwise noted.

Table 4.

| Parameter | Test Conditions/Comments | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCE <br> Power Conversion Gain <br> Voltage Conversion Gain SSB Noise Figure Input Third-Order Intercept (IIP3) <br> Input Second-Order Intercept (IIP2) <br> Input 1 dB Compression Point (IP1dB) | Including 4:1 IF port transformer and PCB loss <br> $Z_{\text {source }}=50 \Omega$, differential $Z_{\text {LOAD }}=200 \Omega$ differential <br> $f_{R F 1}=2534.5 \mathrm{MHz}, \mathrm{f}_{\mathrm{RF} 2}=2535.5 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=2332 \mathrm{MHz}$, each RF tone at -10 dBm <br> $\mathrm{f}_{\mathrm{RF} 1}=2535 \mathrm{MHz}, \mathrm{f}_{\mathrm{RF} 2}=2585 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=2332 \mathrm{MHz}$, each RF tone at -10 dBm |  | $\begin{aligned} & 8 \\ & 14 \\ & 9.9 \\ & 17.5 \\ & 49 \\ & 4 \\ & 7 \end{aligned}$ |  | dB <br> dB <br> dB <br> dBm <br> dBm <br> dBm |
| POWER INTERFACE <br> Supply Voltage <br> Quiescent Current <br> Power-Down Current | Resistor programmable Device disabled | 3.0 | $\begin{aligned} & 3.3 \\ & 200 \\ & 300 \end{aligned}$ | 3.6 | V <br> mA <br> $\mu \mathrm{A}$ |

## ABSOLUTE MAXIMUM RATINGS

Table 5.

| Parameter | Rating |
| :--- | :--- |
| Supply Voltage, V $\mathrm{V}_{\mathrm{S}}$ | 5.5 V |
| RF Input Level | 20 dBm |
| LO Input Level | 13 dBm |
| MNOP, MNON, DVOP, DVON Bias | 6.0 V |
| VGS2,VGS1,VGSO, LOSW, PWDN | 5.5 V |
| Internal Power Dissipation | 2.2 W |
| Thermal Characteristic $\theta_{\mathrm{JA}}$ | $22^{\circ} \mathrm{C} / \mathrm{W}$ |
| Maximum Junction Temperature | $150^{\circ} \mathrm{C}$ |
| Temperature Range |  |
| $\quad$ Operating | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| $\quad$ Storage | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Lead Temperature (Soldering, 60 sec ) | $260^{\circ} \mathrm{C}$ |

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## ESD CAUTION

|  | ESD (electrostatic discharge) sensitive device. <br> Charged devices and circuit boards can discharge <br> without detection. Although this product features <br> patented or proprietary protection circuitry, damage <br> may occur on devices subjected to high energy ESD. <br> Therefore, proper ESD precautions should be taken to <br> avoid performance degradation or loss of functionality. |
| :--- | :--- |

## ADL5354

## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



Figure 2. Pin Configuration
Table 6. Pin Function Descriptions

| Pin No. | Mnemonic | Description |
| :--- | :--- | :--- |
| 1 | MNIN | RF Input for Main Channel. Internally matched to $50 \Omega$. Must be ac-coupled. |
| 2 | MNCT | Center Tap for Main Channel Input Balun. Bypass to ground using low inductance capacitor. |
| $3,5,7,12,20,34$ | COMM | Device Common (DC Ground). |
| $4,6,10,16,21,30,36$ | VPOS | Positive Supply Voltage. |
| 8 | DVCT | Center Tap for Diversity Channel Input Balun. Bypass to ground using low inductance capacitor. |
| 9 | DVIN | RF Input for Diversity Channel. Internally matched to $50 \Omega$. Must be ac-coupled. |
| 11 | DVGM | Diversity Amplifier Bias Setting. Connect a $1.3 \mathrm{k} \Omega$ resistor to ground for typical operation. |
| 13,14 | DVOP, DVON | Diversity Channel Differential Open-Collector Outputs. DVOP and DVON should be pulled up to |
| 15 | DVLE | VCC using external inductors, see Figure 53 for details. |
| 17 | DVLG | Diversity Channel IF Return. This pin must be grounded. |
| 18,28 | Diversity Channel LO Buffer Bias Setting. Connect a 1 k resistor to ground for typical operation. |  |
| 19 | LOI1 | No Connect. Do not connect to this pin. |
| 22 | PWDN | Local Oscillator Input 1 . Internally matched to $50 \Omega$. Must be ac-coupled. |
| 23 | Power Down. Connect this pin to ground for normal operation. Connect pin to 3 V for disable |  |
| $24,25,26$ | mode when using VPOS 3.6 V. PWDN pin must be grounded when VPOS > 3.6 V. |  |
| 27 | VGSO, VGS1, | Local Oscillator Input Selection Switch. Set LOSW high to select LOI1 or set LOSW low to select LOI2. |
| 29 | Gate to Source Control Voltages. For typical operation, set VGS0, VGS1, and VGS2 to a low logic |  |
| 31 | LOI2 | level. |
| 32,33 | Local Oscillator Input 2. Internally matched to $50 \Omega$. Must be ac-coupled. |  |
| 35 | MNLG | Main Channel LO Buffer Bias Setting. Connect a $1 \mathrm{k} \Omega$ resistor to ground for typical operation. |

## TYPICAL PERFORMANCE CHARACTERISTICS

## 5 V PERFORMANCE

$\mathrm{V}_{\mathrm{s}}=5 \mathrm{~V}, \mathrm{Is}=350 \mathrm{~mA}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{RF}}=2535 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=2332 \mathrm{MHz}$, LO power $=0 \mathrm{dBm}, \mathrm{RF}$ power $=-10 \mathrm{dBm}, \mathrm{R} 1=\mathrm{R} 4=1.3 \mathrm{k} \Omega, \mathrm{R} 2=\mathrm{R} 5=1 \mathrm{k} \Omega$, $\mathrm{Z}_{\mathrm{O}}=50 \Omega$, VGS0 $=\mathrm{VGS} 1=\mathrm{VGS} 2=0 \mathrm{~V}$, unless otherwise noted.


Figure 3. Supply Current vs. RF Frequency


Figure 4. Power Conversion Gain vs. RF Frequency


Figure 5. Input IP3 vs. RF Frequency


Figure 6. Input IP2 vs. RF Frequency


Figure 7. Input P1dB vs. RF Frequency


Figure 8. SSB Noise Figure vs. RF Frequency

## ADL5354

$\mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=350 \mathrm{~mA}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{RF}}=2535 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=2332 \mathrm{MHz}$, LO power $=0 \mathrm{dBm}, \mathrm{RF}$ power $=-10 \mathrm{dBm}, \mathrm{R} 1=\mathrm{R} 4=1.3 \mathrm{k} \Omega, \mathrm{R} 2=\mathrm{R} 5=1 \mathrm{k} \Omega$, $\mathrm{Z} \mathrm{o}=50 \Omega$, VGS0 $=\mathrm{VGS} 1=\mathrm{VGS} 2=0 \mathrm{~V}$, unless otherwise noted.


Figure 9. Supply Current vs. Temperature


Figure 10. Power Conversion Gain vs. Temperature


Figure 11. Input IP3 vs. Temperature


Figure 12. Input IP2 vs. Temperature


Figure 13. Input P1dB vs. Temperature


Figure 14. SSB Noise Figure vs. Temperature
$\mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=350 \mathrm{~mA}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{RF}}=2535 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=2332 \mathrm{MHz}$, LO power $=0 \mathrm{dBm}, \mathrm{RF}$ power $=-10 \mathrm{dBm}, \mathrm{R} 1=\mathrm{R} 4=1.3 \mathrm{k} \Omega$, $\mathrm{R} 2=\mathrm{R} 5=1 \mathrm{k} \Omega, \mathrm{Z}=50 \Omega, \mathrm{VGS} 0=\mathrm{VGS} 1=\mathrm{VGS} 2=0 \mathrm{~V}$, unless otherwise noted.


Figure 15. Supply Current vs. IF Frequency


Figure 16. Power Conversion Gain vs. IF Frequency


Figure 17. Input IP3 vs. IF Frequency


Figure 18. Input IP2 vs. IF Frequency


Figure 19. Input P1dB vs. IF Frequency


Figure 20. SSB Noise Figure vs. IF Frequency

## ADL5354

$\mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=350 \mathrm{~mA}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{RF}}=2535 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=2332 \mathrm{MHz}$, LO power $=0 \mathrm{dBm}, \mathrm{RF}$ power $=-10 \mathrm{dBm}, \mathrm{R} 1=\mathrm{R} 4=1.3 \mathrm{k} \Omega, \mathrm{R} 2=\mathrm{R} 5=1 \mathrm{k} \Omega$, $\mathrm{Z}_{\mathrm{o}}=50 \Omega$, VGS0 $=\mathrm{VGS} 1=\mathrm{VGS} 2=0 \mathrm{~V}$, unless otherwise noted.


Figure 21. Power Conversion Gain vs. LO Power


Figure 22. Input IP3 vs. LO Power


Figure 23. Input IP2 vs. LO Power


Figure 24. Input P1dB vs. LO Power


Figure 25. IF/2 Spurious vs. RF Frequency, RF Power $=-10 \mathrm{dBm}$


Figure 26. IF/3 Spurious vs. RF Frequency, RF Power $=-10 \mathrm{dBm}$
$\mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=350 \mathrm{~mA}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{RF}}=2535 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=2332 \mathrm{MHz}$, LO power $=0 \mathrm{dBm}, \mathrm{RF}$ power $=-10 \mathrm{dBm}, \mathrm{R} 1=\mathrm{R} 4=1.3 \mathrm{k} \Omega, \mathrm{R} 2=\mathrm{R} 5=1 \mathrm{k} \Omega$, $\mathrm{Z}_{\mathrm{o}}=50 \Omega$, VGS0 $=\mathrm{VGS} 1=\mathrm{VGS} 2=0 \mathrm{~V}$, unless otherwise noted.


Figure 27. Conversion Gain Distribution


Figure 28. Input IP3 Distribution


Figure 29. Input P1dB Distribution


Figure 30. IF Output Impedance (R Parallel, C Equivalent)


Figure 31. RF Return Loss, Fixed IF


Figure 32. LO Return Loss, Selected and Unselected

## ADL5354

$\mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}, \mathrm{IS}=350 \mathrm{~mA}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{RF}}=2535 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=2332 \mathrm{MHz}$, LO power $=0 \mathrm{dBm}$, RF power $=-10 \mathrm{dBm}, \mathrm{R} 1=\mathrm{R} 4=1.3 \mathrm{k} \Omega$, $\mathrm{R} 2=\mathrm{R} 5=1 \mathrm{k} \Omega, \mathrm{Z}_{\mathrm{o}}=50 \Omega, \mathrm{VGS} 0=\mathrm{VGS} 1=\mathrm{VGS} 2=0 \mathrm{~V}$, unless otherwise noted.


Figure 33. LO Switch Isolation vs. RF Frequency


Figure 34 RF-to-IF Isolation vs. RF Frequency


Figure 35. LO-to-IF Leakage vs. LO Frequency


Figure 36. LO-to-RF Leakages vs. LO Frequency


Figure $37.2 \times$ LO Leakage vs. LO Frequency


Figure 38. $3 \times$ LO Leakage vs. LO Frequency
$\mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=350 \mathrm{~mA}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{RF}}=2535 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=2332 \mathrm{MHz}$, LO power $=0 \mathrm{dBm}, \mathrm{RF}$ power $=-10 \mathrm{dBm}, \mathrm{R} 1=\mathrm{R} 4=1.3 \mathrm{k} \Omega, \mathrm{R} 2=\mathrm{R} 5=1 \mathrm{k} \Omega$, $\mathrm{Z} \mathrm{o}=50 \Omega$, VGS0 $=\mathrm{VGS} 1=\mathrm{VGS} 2=0 \mathrm{~V}$, unless otherwise noted.


Figure 39. Power Conversion Gain and SSB Noise Figure vs. RF Frequency for Various VGS Settings


Figure 40. Input P1dB and Input IP3 vs. RF Frequency for Various VGS Settings


Figure 41. Power Conversion Gain, SSB Noise Figure, and Input IP3 vs. LO Bias Resistor Value


Figure 42. LO and IF Supply Current vs. IF and LO Bias Resistor Value


Figure 43. Power Conversion Gain, SSB Noise Figure, and Input IP3 vs. IF Bias Resistor Value


Figure 44. IF Channel-to-Channel Isolation vs. RF Frequency

## ADL5354

### 3.3 V PERFORMANCE

$\mathrm{V}_{\mathrm{S}}=3.3 \mathrm{~V}, \mathrm{I} \mathrm{I}=200 \mathrm{~mA}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{RF}}=2535 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=2332 \mathrm{MHz}$, LO power $=0 \mathrm{dBm}, \mathrm{R} 9=226 \Omega, \mathrm{R} 14=604 \Omega$, VGS0 $=\mathrm{VGS} 1=0 \mathrm{~V}$, and $Z_{o}=50 \Omega$, unless otherwise noted.


Figure 45. Supply Current vs. RF Frequency at 3.3 V


Figure 46. Power Conversion Gain vs. RF Frequency at 3.3 V


Figure 47. Input IP3 vs. RF Frequency at 3.3 V


Figure 48. Input IP2 vs. RF Frequency at 3.3 V


Figure 49. Input P1dB vs. RF Frequency at 3.3 V


Figure 50. SSB Noise Figure vs. RF Frequency at 3.3 V

## ADL5354

## SPUR TABLES

All spur tables are $\left(N \times f_{\text {RF }}\right)-\left(M \times f_{L O}\right)$ and were measured using the standard evaluation board. Mixer spurious products are measured in dBc from the IF output power level. Data was measured only for frequencies less than 6 GHz . Typical noise floor of the measurement system $=-100 \mathrm{dBm}$.

## 5 V PERFORMANCE

$\mathrm{V}_{\mathrm{S}}=5 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=350 \mathrm{~mA}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{RF}}=2500 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=2297 \mathrm{MHz}$, LO power $=0 \mathrm{dBm}$, RF power $=-10 \mathrm{dBm}, \mathrm{VGS} 0=\mathrm{VGS} 1=\mathrm{VGS} 2=0 \mathrm{~V}$, and $Z_{O}=50 \Omega$, unless otherwise noted.


### 3.3 V PERFORMANCE

$\mathrm{V}_{\mathrm{S}}=3.3 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=200 \mathrm{~mA}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{RF}}=2500 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=2297 \mathrm{MHz}, \mathrm{LO}$ power $=0 \mathrm{dBm}, \mathrm{RF}$ power $=-10 \mathrm{dBm}, \mathrm{R} 1=\mathrm{R} 4=1.2 \mathrm{k} \Omega$, $\mathrm{R} 2=$ $\mathrm{R} 5=400 \Omega$, VGS0 $=\mathrm{VGS} 1=\mathrm{VG} 2=0 \mathrm{~V}$, and $\mathrm{Z}_{\mathrm{o}}=50 \Omega$, unless otherwise noted.

|  |  | M |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 |
|  | 0 |  | -26.5 | -36.3 |  |  |  |  |  |  |  |  |  |  |  |  |
|  | 1 | -40.6 | 0.00 | -58.8 | -55.5 |  |  |  |  |  |  |  |  |  |  |  |
|  | 2 | -87.8 | -77.7 | -64.2 | -79.1 | -84.3 |  |  |  |  |  |  |  |  |  |  |
|  | 3 |  | <-100 | <-100 | -70.2 | <-100 | <-100 |  |  |  |  |  |  |  |  |  |
|  | 4 |  |  | <-100 | <-100 | <-100 | <-100 | <-100 | <-100 |  |  |  |  |  |  |  |
|  | 5 |  |  |  | <-100 | <-100 | <-100 | <-100 | <-100 | <-100 | <-100 |  |  |  |  |  |
|  | 6 |  |  |  |  | <-100 | <-100 | <-100 | <-100 | <-100 | <-100 | <-100 |  |  |  |  |
| N | 7 |  |  |  |  |  |  | <-100 | <-100 | <-100 | <-100 | <-100 | <-100 |  |  |  |
| N | 8 |  |  |  |  |  |  |  | <-100 | <-100 | <-100 | <-100 | <-100 |  |  |  |
|  | 9 |  |  |  |  |  |  |  |  | <-100 | <-100 | <-100 | <-100 | <-100 |  |  |
|  | 10 |  |  |  |  |  |  |  |  |  | <-100 | <-100 | <-100 | <-100 | <-100 |  |
|  | 11 |  |  |  |  |  |  |  |  |  |  | <-100 | <-100 | <-100 | <-100 | <-100 |
|  | 12 |  |  |  |  |  |  |  |  |  |  |  | <-100 | <-100 | <-100 | <-100 |
|  | 13 |  |  |  |  |  |  |  |  |  |  |  |  | <-100 | <-100 | <-100 |
|  | 14 |  |  |  |  |  |  |  |  |  |  |  |  |  | <-100 | <-100 |
|  | 15 |  |  |  |  |  |  |  |  |  |  |  |  |  |  | <-100 |

## ADL5354

## CIRCUIT DESCRIPTION

The ADL5354 consists of two primary components: the radio frequency (RF) subsystem and the local oscillator (LO) subsystem. The combination of design, process, and packaging technology allows the functions of these subsystems to be integrated into a single die using mature packaging and interconnection technologies to provide a high performance, low cost design with excellent electrical, mechanical, and thermal properties. In addition, the need for external components is minimized, optimizing cost and size.

The RF subsystem consists of integrated, low loss RF baluns, passive MOSFET mixers, sum termination networks, and IF amplifiers. The LO subsystem consists of an SPDT-terminated FET switch and two multistage limiting LO amplifiers. The purpose of the LO subsystem is to provide a large, fixed amplitude, balanced signal to drive the mixer independent of the level of the LO input. A block diagram of the device is shown in Figure 51.


## RF SUBSYSTEM

The single-ended, $50 \Omega \mathrm{RF}$ input is internally transformed to a balanced signal using a low loss ( $<1 \mathrm{~dB}$ ) unbalanced-to-balanced (balun) transformer. This transformer is made possible by an extremely low loss metal stack, which provides both excellent balance and dc isolation for the RF port. Although the port can be dc connected, it is recommended that a blocking capacitor be used to avoid running excessive dc current through the part. The RF balun can easily support an RF input frequency range of 2200 MHz to 2700 MHz .

The resulting balanced RF signal is applied to a passive mixer that commutates the RF input with the output of the LO subsystem. The passive mixer is essentially a balanced, low loss switch that adds minimal noise to the frequency translation. The only noise
contribution from the mixer is due to the resistive loss of the switches, which is in the order of a few ohms.

Because the mixer is inherently broadband and bidirectional, it is necessary to properly terminate all the idler ( $\mathrm{M} \times \mathrm{N}$ product) frequencies generated by the mixing process. Terminating the mixer avoids the generation of unwanted intermodulation products and reduces the level of unwanted signals at the input of the IF amplifier, where high peak signal levels can compromise the compression and intermodulation performance of the system. This termination is accomplished by the addition of a sum network between the IF amplifier and the mixer and in the feedback elements in the IF amplifier.

The IF amplifier is a balanced feedback design that simultaneously provides the desired gain, noise figure, and input impedance that is required to achieve the overall performance. The balanced opencollector output of the IF amplifier, with impedance modified by the feedback within the amplifier, permits the output to be connected directly to a high impedance filter, differential amplifier, or an analog-to-digital input while providing optimum second-order intermodulation suppression. The differential output impedance of the IF amplifier is approximately $200 \Omega$. If operation in a $50 \Omega$ system is desired, the output can be transformed to $50 \Omega$ by using a 4:1 transformer.

The intermodulation performance of the design is generally limited by the IF amplifier. The IP3 performance can be optimized by adjusting the IF current with an external resistor. Additionally, dc current can be saved by increasing either or both resistors. It is permissible to reduce the dc supply voltage to as low as 3.3 V , further reducing the dissipated power of the part. (No performance enhancement is obtained by reducing the value of these resistors, and excessive dc power dissipation may result.)

## LO SUBSYSTEM

The ADL5354 has two LO inputs permitting multiple synthesizers to be rapidly switched with extremely short switching times ( $<40 \mathrm{~ns}$ ) for frequency agile applications. The two inputs are applied to a high isolation SPDT switch that provides a constant input impedance, regardless of whether the port is selected, to avoid pulling the LO sources. This multiple section switch also ensures high isolation to the off input, minimizing any leakage from the unwanted LO input that may result in undesired IF responses.

The single-ended LO input is converted to a fixed amplitude differential signal using a multistage, limiting LO amplifier. This results in consistent performance over a range of LO input power. Optimum performance is achieved from -6 dBm to +10 dBm , but the circuit continues to function at considerably lower levels of LO input power.

The performance of this amplifier is critical in achieving a high intercept passive mixer without degrading the noise floor of the
system. This is a critical requirement in an interferer rich environment, such as cellular infrastructure, where blocking interferers can limit mixer performance. The bandwidth of the intermodulation performance is somewhat influenced by the current in the LO amplifier chain. For dc current sensitive applications, it is permissible to reduce the current in the LO amplifier by raising the value of the external bias control resistor. For dc current critical applications, the LO chain can operate with a supply voltage as low as 3.3 V , resulting in substantial dc power savings.

In addition, when operating with supply voltages below 3.6 V , the ADL5354 has a power-down mode that permits the dc current to drop to $\sim 300 \mu \mathrm{~A}$.
The logic inputs are designed to work with any logic family that provides a Logic 0 input level of less than 0.4 V and a Logic 1 input level that exceeds 1.4 V . All logic inputs are high impedance up to Logic 1 levels of 3.3 V. At levels exceeding 3.3 V, protection circuitry permits operation up to 5.5 V , although a small bias current is drawn.
All pins, including the RF pins, are ESD protected and have been tested to a level of 1500 V HBM and 500 V FICDM.

## APPLICATIONS INFORMATION

## BASIC CONNECTIONS

The ADL5354 mixer is designed to downconvert radio frequencies (RF) primarily between 2200 MHz and 2700 MHz to lower intermediate frequencies (IF) between 30 MHz and 450 MHz . Figure 52 depicts the basic connections of the mixer. It is recommended to ac couple the RF and LO input ports to prevent nonzero dc voltages from damaging the RF balun or LO input circuit. The RFIN matching network consists of a series 1.5 pF capacitor and a shunt 4.3 nH inductor to provide the optimized RF input return loss for the desired frequency band.

## IF PORT

The mixer differential IF interface requires pull-up choke inductors to bias the open-collector outputs and to set the output match. The shunting impedance of the choke inductors used to couple dc current into the IF amplifier should be selected to provide the desired output return loss.
The real part of the output impedance is approximately $200 \Omega$, which matches many commonly used SAW filters without the
need for a transformer. This results in a voltage conversion gain that is approximately 6 dB higher than the power conversion gain, as shown in Table 3. When a $50 \Omega$ output impedance is needed, use a 4:1 impedance transformer, as shown in Figure 52.

## BIAS RESISTOR SELECTION

The IF bias resistors (R1 and R4) and LO bias resistors (R2 and R5) are used to adjust the bias current of the integrated amplifiers at the IF and LO terminals. It is necessary to have a sufficient amount of current to bias both the internal IF and LO amplifiers to optimize dc current vs. optimum IIP3 performance.

## MIXER VGS CONTROL DAC

The ADL5354 features three logic control pins, VGS0 (Pin 24), VGS1 (Pin 25), and VGS2 (Pin26), that allow programmability for internal gate-to-source voltages for optimizing mixer performance over desired frequency bands. The evaluation board defaults VGS0, VGS1, and VGS2 to ground.


Figure 52. Typical Application Circuit

## ADL5354

## EVALUATION BOARD

An evaluation board is available for the family of double balanced mixers. The standard evaluation board schematic is shown in Figure 53. The evaluation board is fabricated using Rogers ${ }^{\circ}$

RO3003 material. Table 7 describes the various configuration options of the evaluation board. Evaluation board layout is shown in Figure 54 and Figure 55.


Table 7. Evaluation Board Configuration

| Components | Description | Default Conditions |
| :---: | :---: | :---: |
| $\begin{aligned} & \text { C1, C8, C10, C12, } \\ & \text { C13, C15, C18, } \\ & \text { C21, C22, C23, } \\ & \text { C24, C25, C26 } \end{aligned}$ | Power supply decoupling. Nominal supply decoupling consists of a $0.01 \mu \mathrm{~F}$ capacitor to ground in parallel with 10 pF capacitors to ground positioned as close to the device as possible. | $\begin{aligned} & \mathrm{C} 10=4.7 \mu \mathrm{~F} \text { (Size } 3216), \\ & \mathrm{C} 1, \mathrm{C}, \mathrm{C} 12, \mathrm{C} 21=150 \mathrm{pF} \text { (Size 0402), } \\ & \mathrm{C} 22, \mathrm{C} 23, \mathrm{C} 24, \mathrm{C} 25, \mathrm{C} 26=10 \mathrm{pF}(\text { Size 0402), } \\ & \mathrm{C} 13, \mathrm{C} 15, \mathrm{C} 18=0.1 \mu \mathrm{~F} \text { (Size 0402) } \end{aligned}$ |
| $\begin{aligned} & \text { Z1 to Z4, C2, C3, } \\ & \text { C6, C7, C9, C11 } \end{aligned}$ | RF main and diversity input interface. Main and diversity input channels are ac-coupled through C9 and C11. Z1 to Z4 provide additional component placement for external matching/filter networks. C2, C3, C6, and C7 provide bypassing for the center taps of the main and diversity on-chip input baluns. | C2, C7 = 10 pF (Size 0402), <br> C3, C6 $=0.01 \mu \mathrm{~F}$ (Size 0402), <br> C9, C11 = 1.5 pF (Size 0402), <br> Z2, Z4 = 4.3 nH (Size 0402), <br> Z1, Z3 = open (Size 0402) |
| $\begin{aligned} & \hline \text { T1, T2, C17, C19, } \\ & \text { C20, C27 to C33, } \\ & \text { L1, L2, L4, L5, } \\ & \text { R3, R6, R9, R10 } \end{aligned}$ | IF main and diversity output interface. The open-collector IF output interfaces are biased through the pull-up choke inductors (L1, L2, L4, and L5), leaving R3 and R6 available for additional supply bypassing. T1 and T2 are 4:1 impedance transformers that are used to provide a single-ended IF output interface, and C27 and C28 provide the center tap bypassing. C17, C19, C20, C29, C30, C31, C32, and C33 ensure an ac-coupled output interface. Remove R9 and R10 for balanced output operation. | C17, C19, C20, C29 to C33 = $0.001 \mu$ F (Size 0402), <br> C27, C28 = 150 pF (Size 0402), <br> T1, T2 = TC4-1T+ (Mini-Circuits), <br> L1, L2, L4, L5 = 330 nH (Size 0805), <br> R3, R6, R9, R10 $=0 \Omega$ (Size 0402) |
| $\begin{aligned} & \text { C14, C16, } \\ & \text { R15, LOSEL } \end{aligned}$ | LO interface. C14 and C16 provide ac coupling for the LOI1 and LOI2 local oscillator inputs. LOSEL selects the appropriate LO input for both mixer cores. R15 provides a pull-down to ensure LOI2 is enabled when the LOSEL jumper is removed. The jumper can be removed to allow the LOSEL interface to be exercised by using an external logic generator. | $\begin{aligned} & \text { C14, C16 = } 10 \mathrm{pF} \text { (Size 0402), } \\ & \text { R15 = } 10 \mathrm{k} \Omega \text { (Size 0402), } \\ & \text { LOSEL }=2 \text {-pin shunt } \end{aligned}$ |
| R19, PWDN | PWDN interface. When the PWDN 2-pin shunt is inserted, the ADL5354 is powered down. When R19 is open, it pulls the PWDN logic low and enables the device. The jumper can be removed to allow PWDN interface to be exercised using an external logic generator. Grounding the PWDN pin is allowed during nominal operation but is not permitted when supply voltages exceed 3.3 V . | $\text { R19 = } 10 \mathrm{k} \Omega \text { (Size 0402), }$ <br> PWDN $=2$-pin shunt |
| $\begin{aligned} & \hline \text { R1, R2, R4, R5, L3, } \\ & \text { L6, R7, R8, R11 to } \\ & \text { R14, R16, R17, C34 } \end{aligned}$ | Bias control. R16 and R17 form a voltage divider to provide a 3 V for logic control, bypassed to ground through C34. Resistors R7, R8, R11, R12, R13, and R14 provide resistor programmability of VGS0, VGS1, and VGS2. Typically, these nodes can be hardwired for nominal operation. Grounding these pins is allowed for nominal operation. R2 and R5 set the bias point for the internal LO buffers. R1 and R4 set the bias point for the internal IF amplifiers. L3 and L6 are external inductors used to improve isolation and common-mode rejection. | $\begin{aligned} & \hline \text { R1, R4 }=1.3 \mathrm{k} \Omega \text { (Size 0402), } \\ & \text { R2, R5 }=1 \mathrm{k} \Omega \text { (Size 0402), } \\ & \text { L3, L6 }=0 \Omega \text { (Size 0603), } \\ & \text { R12, R13, R14 = open (Size 0402), } \\ & \text { R7, R8, R11 = } 0 \text { (Size 0402), } \\ & \text { R16 }=10 \mathrm{k} \Omega \text { (Size 0402), } \\ & \text { R17 }=15 \mathrm{k} \Omega \text { (Size 0402), } \\ & \text { C34 }=1 \mathrm{nF} \text { (Size 0402) } \end{aligned}$ |



Figure 54. Evaluation Board Top Layer


Figure 55. Evaluation Board Bottom Layer

## ADL5354

## OUTLINE DIMENSIONS



## ORDERING GUIDE

| Model $^{1}$ | Temperature Range | Package Description | Package Option |
| :--- | :--- | :--- | :--- |
| ADL5354ACPZ-R2 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 36 -Lead LFCSP_VQ | CP-36-1 |
| ADL5354ACPZ-R7 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 36 -Lead LFCSP_VQ | CP-36-1 |
| ADL5354-EVALZ |  | Evaluation Board |  |

[^1]NOTES

## ADL5354

## NOTES


[^0]:    ${ }^{1}$ Apply supply voltage from external circuit through choke inductors.
    ${ }^{2}$ PWDN function is intended for use with $\mathrm{V}_{\mathrm{S}} \leq 3.6 \mathrm{~V}$ only.

[^1]:    ${ }^{1} Z=$ RoHS Compliant Part.

